

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ELECTRONICS AND TELECOMMUNICATIONS RESEARCH INSTITUTE	01/05/2022
RECEIVING PARTY DATA	
Name:	EDUHASH GLOBAL PARTNERS CO., LTD.
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Property Type	Number
Patent Number:	9021609
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DATE SIGNED:	01/20/2022
Total Attachments: 2	
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**UNITED STATES OF AMERICA
ASSIGNMENT**

In consideration of the payment of ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

ASSIGNOR:

ELECTRONICS AND TELECOMMUNICATIONS RESEARCH INSTITUTE
218, Gajeong-ro, Yuseong-gu, Daejeon 34129, Republic of Korea

hereby sells, assigns and transfers to

ASSIGNEE:

Eduhash Global Partners Co., Ltd.
11F, 347, Yeongdeungpo-ro, Yeongdeungpo-gu, Seoul 07318, Republic of Korea

and the successors, assigns and legal representatives of the ASSIGNEE the entire right, title and interest for the United States and its territorial possessions in and to, any and all improvements which are disclosed in the Application entitled

TITLE OF INVENTION:

**APPARATUS AND METHOD FOR VERIFYING INTEGRITY OF FIRMWARE OF
EMBEDDED SYSTEM**

and which is found in (37 CFR 3.21):

- U.S. patent application No. 13/941,520 filed on July 14, 2013 which was issued as U.S. patent No. 9,021,609 dated April 28, 2015

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute thereof, and as to letters patent any reissue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the

same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I/we have set our hand and seal

Note: The date of signing must be the same as the date of execution of the application if item (a) was checked above.

January 5, 2022

Date

Park Jae Hyung

By PARK, Jae Hyung
Manager of Project & IP Management
Section of ELECTRONICS AND
TELECOMMUNICATIONS RESEARCH
INSTITUTE